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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

U.S. Serial No. 10/749,650) I hereby certify that this paper (and/or fee)
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Applicants: Park) Postal Service as first class mail in an
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Title: Methods of Forming Metal)
Lines in Semiconductor Devices) Mail Stop Amendment
) Commissioner for Patents
Filed: December 30, 2003) P.O. Box 1450
) Alexandria, VA 22313-1450
TC/AU: 2891) on this date:
10,110. 2091) //-
Examiner: Lee, Granvill) Dated: 7/14/2005
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Docket No.:) $1/0/2$
20067/OPP031479US) Club (-
	Mark C. Zimmerman
•) Registration No. 44,006

Mail Stop Amendment Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

RESPONSE TO THE OFFICE ACTION DATED APRIL 15, 2005

Dear Sir:

Please enter the following amendments and consider the following remarks.

The Status of the Claims is reflected in the listing of claims that begins on page 2 of this paper.

Remarks begin on page 5 of this paper.